



# 600V Super-junction Power MOSFET

## Description

### 600V Super-junction Power MOSFET

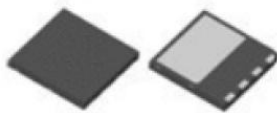
Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFETs, designed according to the SJ principle. The deep trench SJ MOSFET provide an extremely low switching, commutation and conduction losses device with highest robustness make especially resonant switching applications more reliable, more efficient, lighter and cooler, designed by Wuxi Unigroup Microelectronics Company

## Features

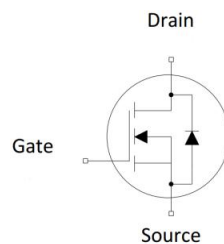
- Ultra-fast body diode
- Very low FOM  $R_{DS(on)} \times Q_g$
- Easy to use/drive
- 100% avalanche tested
- RoHS compliant

## Applications

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)
- LLC Half-bridge
- Charger



DFN8×8



## Device Marking and Package Information

| Device        | Package | Marking    |
|---------------|---------|------------|
| TPG60R070DFDH | DFN8*8  | 60R070DFDH |

## Key Performance Parameters

| Parameter            | Value | Unit     |
|----------------------|-------|----------|
| $V_{DS} @ T_{j,max}$ | 650   | V        |
| $R_{DS(on),max}$     | 0.07  | $\Omega$ |
| $Q_{g,typ}$          | 81    | nC       |
| $I_D$                | 45    | A        |
| $I_{D,pulse}$        | 135   | A        |
| $E_{OSS} @ 400V$     | 10.29 | $\mu J$  |
| $t_{rr}$             | 176   | ns       |
| $Q_{rr}$             | 1.4   | $\mu C$  |
| $I_{rrm}$            | 16    | A        |



| Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ , unless otherwise noted |                           |                |                  |                  |
|--|---------------------------|----------------|------------------|------------------|
| Parameter  |                           | Symbol         | Values           | Unit             |
| Continuous Drain Current   | $T_C = 25^\circ\text{C}$  | $I_D$          | 45               | A                |
|  | $T_C = 100^\circ\text{C}$ |                | 27               |                  |
| Pulsed Drain Current   | (note1)                   | $I_{D,pulse}$  | 135              | A                |
| Gate-Source Voltage  |                           | $V_{GSS}$      | $\pm 30\text{V}$ | V                |
| Single Pulse Avalanche Energy  | (note2)                   | $E_{AS}$       | 180              | mJ               |
| Repetitive Avalanche Energy  | (note2)                   | $E_{AR}$       | 144              | mJ               |
| Avalanche Current  |                           | $I_{AR}$       | 6                | A                |
| MOSFET dv/dt Ruggedness, $V_{DS} = 0 \dots 600\text{V}$                    |                           | dv/dt          | 50               | V/ns             |
| Power Dissipation For DFN8*8   |                           | $P_D$          | 312              | W                |
| Continuous Diode Forward Current   |                           | $I_S$          | 45               | A                |
| Diode Pulsed Current   | (note1)                   | $I_{S,pulse}$  | 135              |                  |
| Reverse Diode dv/dt  | (note3)                   | dv/dt          | 50               | V/ns             |
| Operating Junction and Storage Temperature Range                           |                           | $T_J, T_{stg}$ | $-55 \sim +150$  | $^\circ\text{C}$ |

| Thermal Resistance For DFN8*8           |            |       |                           |
|---|------------|-------|---------------------------|
| Parameter                               | Symbol     | Value | Unit                      |
| Thermal Resistance, Junction-to-Case    | $R_{thJC}$ | 0.4   | $^\circ\text{C}/\text{W}$ |
| Thermal Resistance, Junction-to-Ambient | $R_{thJA}$ | 62    |                           |



| Electrical Characteristics $T_J = 25^\circ\text{C}$ , unless otherwise noted |               |  |       |       |           |               |
|--|---------------|--|-------|-------|-----------|---------------|
| Parameter  | Symbol        | Test Conditions  | Value |       |           | Unit          |
|  |               |  | Min.  | Typ.  | Max.      |               |
| <b>Static Characteristics</b>  |               |  |       |       |           |               |
| Drain-Source Breakdown Voltage   | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 250\mu\text{A}$                        | 600   | --    | --        | V             |
| Zero Gate Voltage Drain Current  | $I_{DSS}$     | $V_{DS} = 600V, V_{GS} = 0V, T_J = 25^\circ\text{C}$       | --    | --    | 5         | $\mu\text{A}$ |
|  |               | $V_{DS} = 600V, V_{GS} = 0V, T_J = 150^\circ\text{C}$      | --    | --    | 100       |               |
| Gate-Source Leakage Current  | $I_{GSS}$     | $V_{GS} = \pm 30V$   | --    | --    | $\pm 100$ | nA            |
| Gate-Source Threshold Voltage  | $V_{GS(th)}$  | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$                    | 2.5   | --    | 4.5       | V             |
| Drain-Source On-State-Resistance   | $R_{DS(on)}$  | $V_{GS} = 10V, I_D = 22.5A$                                | --    | 0.056 | 0.07      | $\Omega$      |
| Gate Resistance  | $R_G$         | $f = 1.0\text{MHz}$ open drain                             | --    | 1     | --        | $\Omega$      |
| <b>Dynamic Characteristics</b>   |               |  |       |       |           |               |
| Input Capacitance  | $C_{iss}$     | $V_{GS} = 0V,$<br>$V_{DS} = 100V,$<br>$f = 1.0\text{MHz}$  | --    | 4640  | --        | $\text{pF}$   |
| Output Capacitance   | $C_{oss}$     |  | --    | 123   | --        |               |
| Reverse Transfer Capacitance   | $C_{rss}$     |  | --    | 3.55  | --        |               |
| Total Gate Charge  | $Q_g$         | $V_{DD} = 480V, I_D = 45A,$<br>$V_{GS} = 10V$              | --    | 81    | --        | $\text{nC}$   |
| Gate-Source Charge   | $Q_{gs}$      |  | --    | 25    | --        |               |
| Gate-Drain Charge  | $Q_{gd}$      |  | --    | 24    | --        |               |
| Turn-on Delay Time   | $t_{d(on)}$   | $V_{DD} = 400V, I_D = 45A,$<br>$R_G = 25\Omega$            | --    | 107   | --        | $\text{ns}$   |
| Turn-on Rise Time  | $t_r$         |  | --    | 80    | --        |               |
| Turn-off Delay Time  | $t_{d(off)}$  |  | --    | 164   | --        |               |
| Turn-off Fall Time   | $t_f$         |  | --    | 52    | --        |               |
| <b>Drain-Source Body Diode Characteristics</b>                               |               |  |       |       |           |               |
| Body Diode Forward Voltage   | $V_{SD}$      | $T_J = 25^\circ\text{C}, I_{SD} = 22.5A, V_{GS} = 0V$      | --    | 0.9   | 1.2       | V             |
| Reverse Recovery Time  | $t_{rr}$      | $V_R = 400V, I_S = 22.5A,$<br>$di_F/dt = 100A/\mu\text{s}$ | --    | 176   | --        | ns            |
| Reverse Recovery Charge  | $Q_{rr}$      |  | --    | 1.4   | --        | $\mu\text{C}$ |
| Peak Reverse Recovery Current  | $I_{rrm}$     |  | --    | 16    | --        | A             |

**Notes**

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2.  $I_D = 10A, V_{DD} = 50V, R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$
3. Identical low side and high side switch with identical  $R_G$



Typical Characteristics  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Figure 1. Output Characteristics

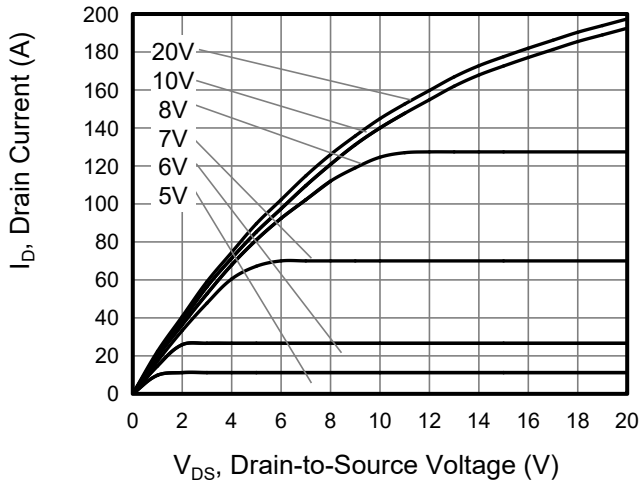


Figure 2. Transfer Characteristics

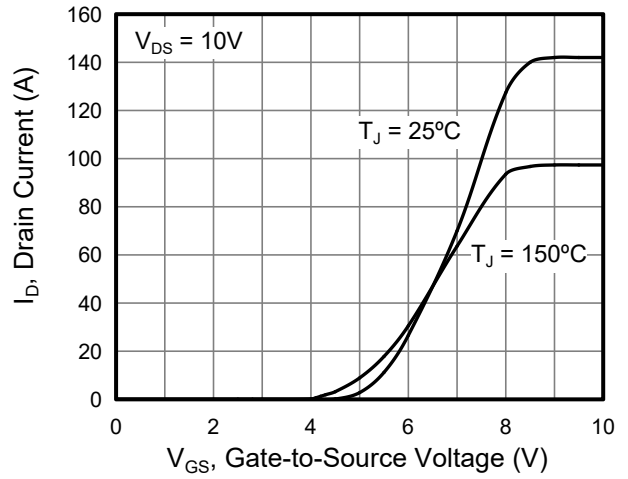


Figure 3. On-Resistance vs. Drain Current

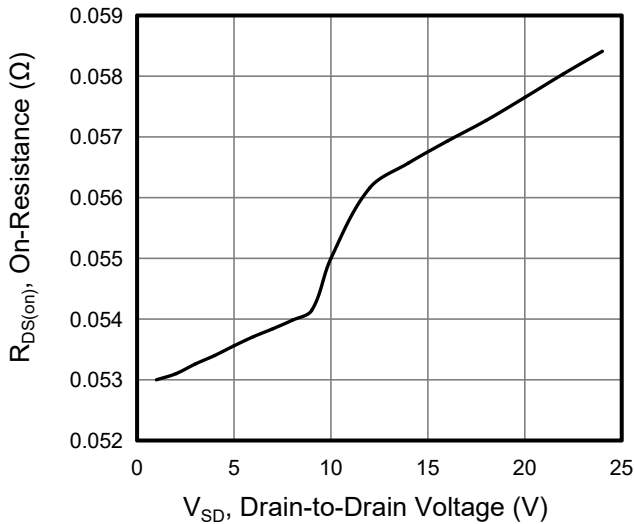


Figure 4. Capacitance

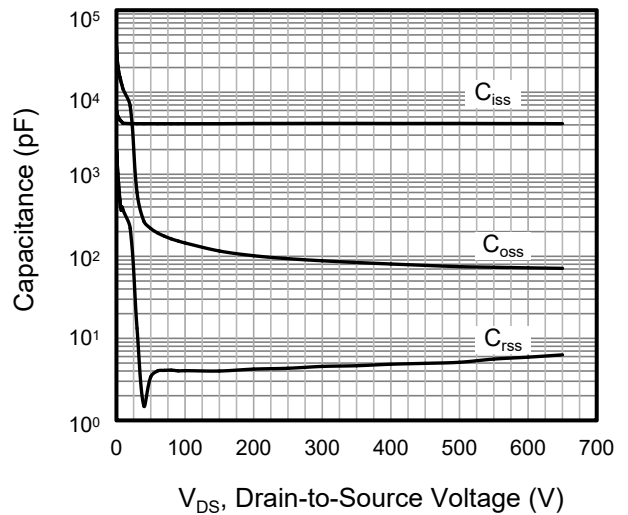


Figure 5. Gate Charge

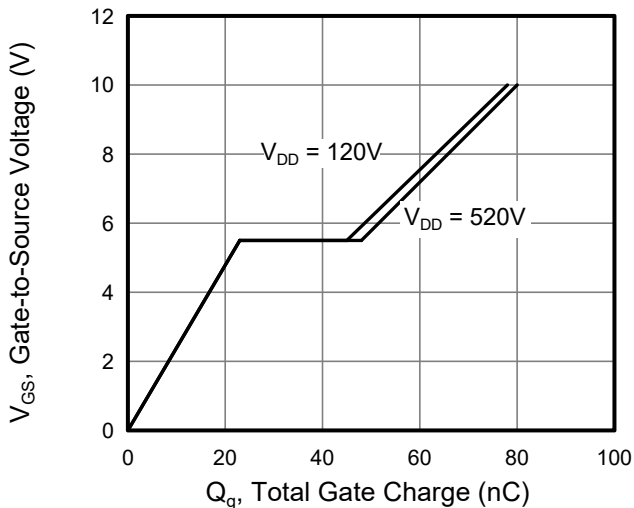


Figure 6. Body Diode Forward Voltage

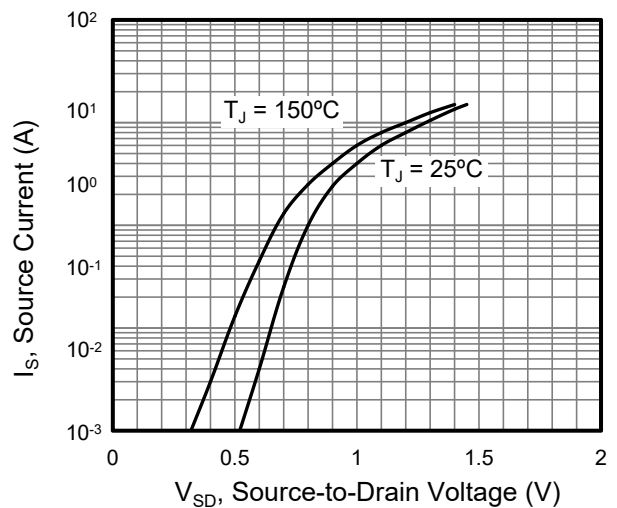




Figure 7. On-Resistance vs. Temperature

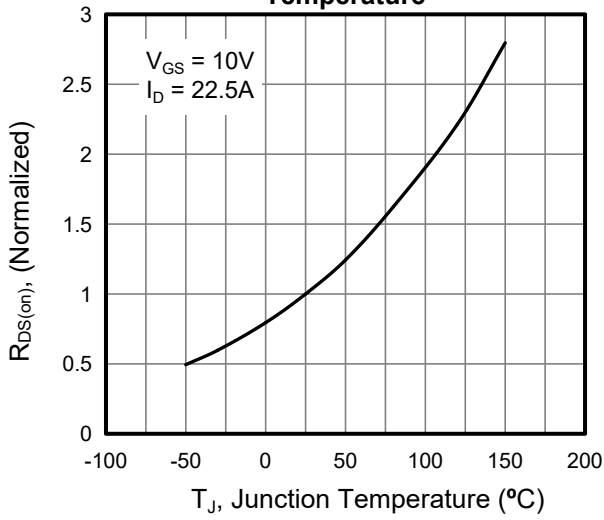


Figure 8. Breakdown voltage vs. Junction Temperature

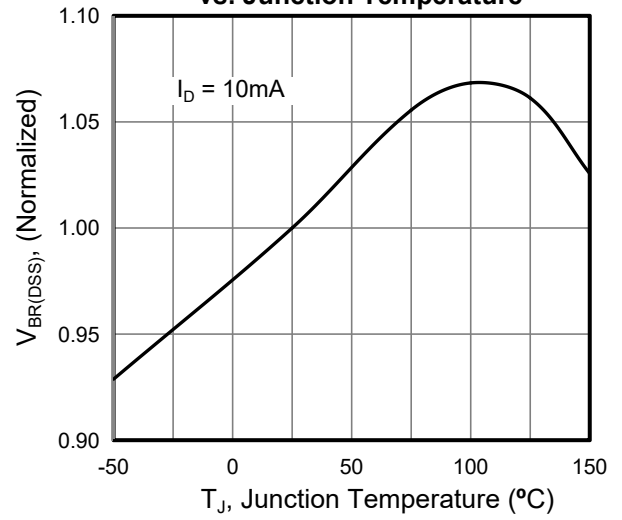


Figure 9. Transient Thermal Impedance For DFN8\*8

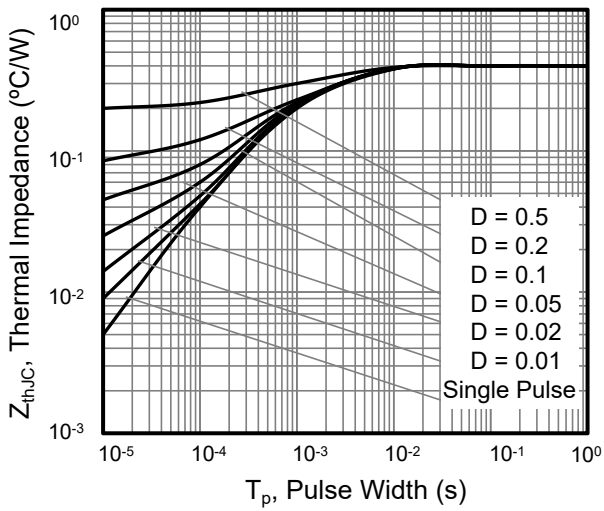


Figure 10. Safe Operation Area For DFN8\*8

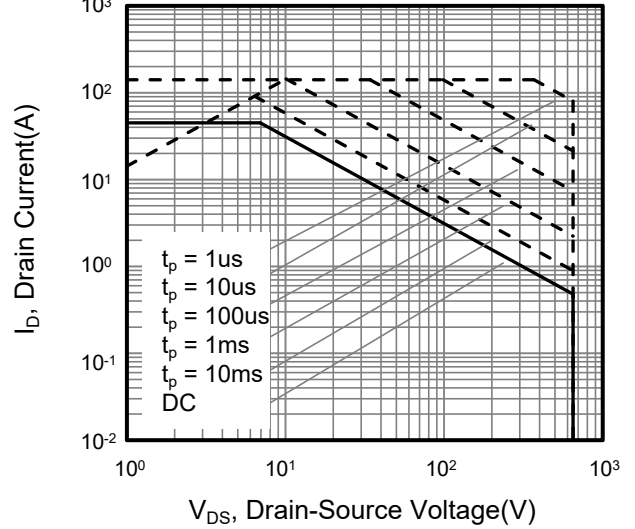


Figure 11. Typ. Coss Stored Energy

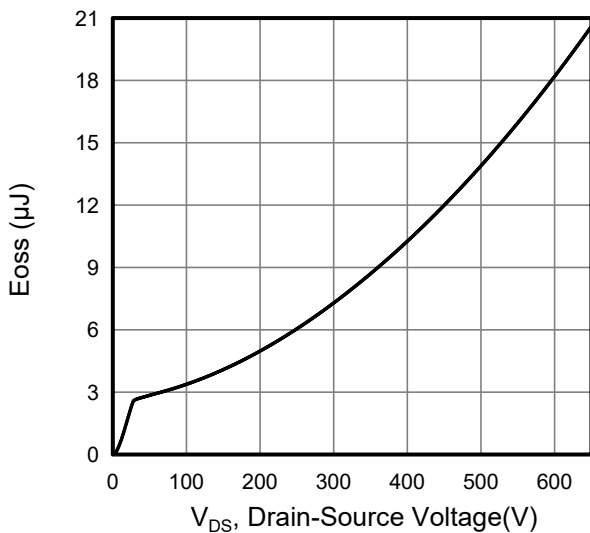




Figure A: Gate Charge Test Circuit and Waveform

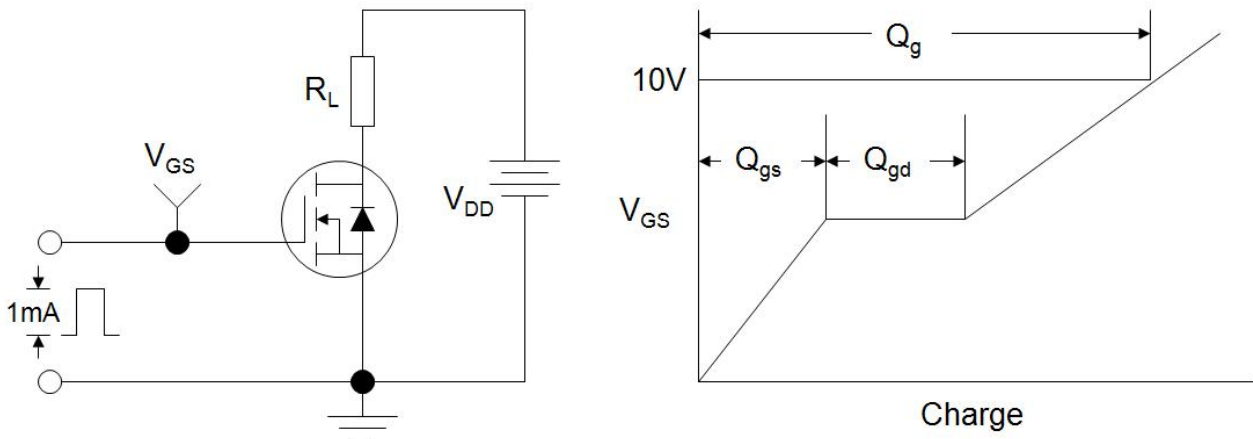


Figure B: Resistive Switching Test Circuit and Waveform

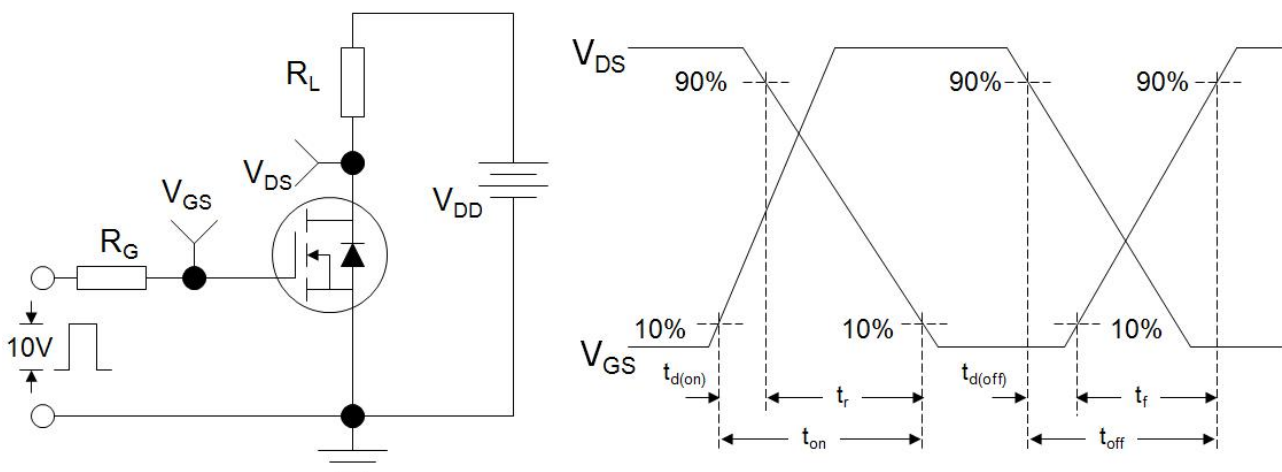
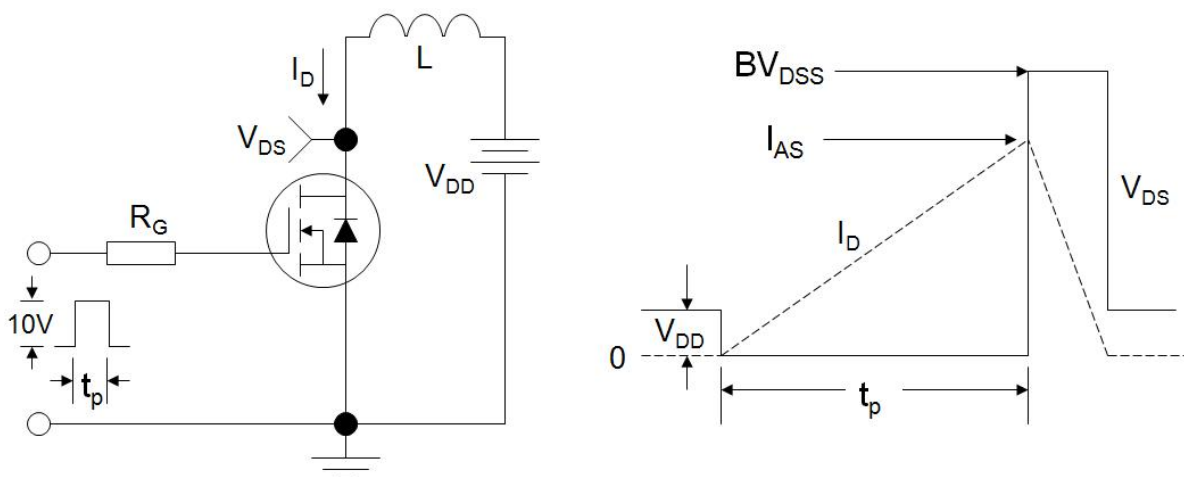
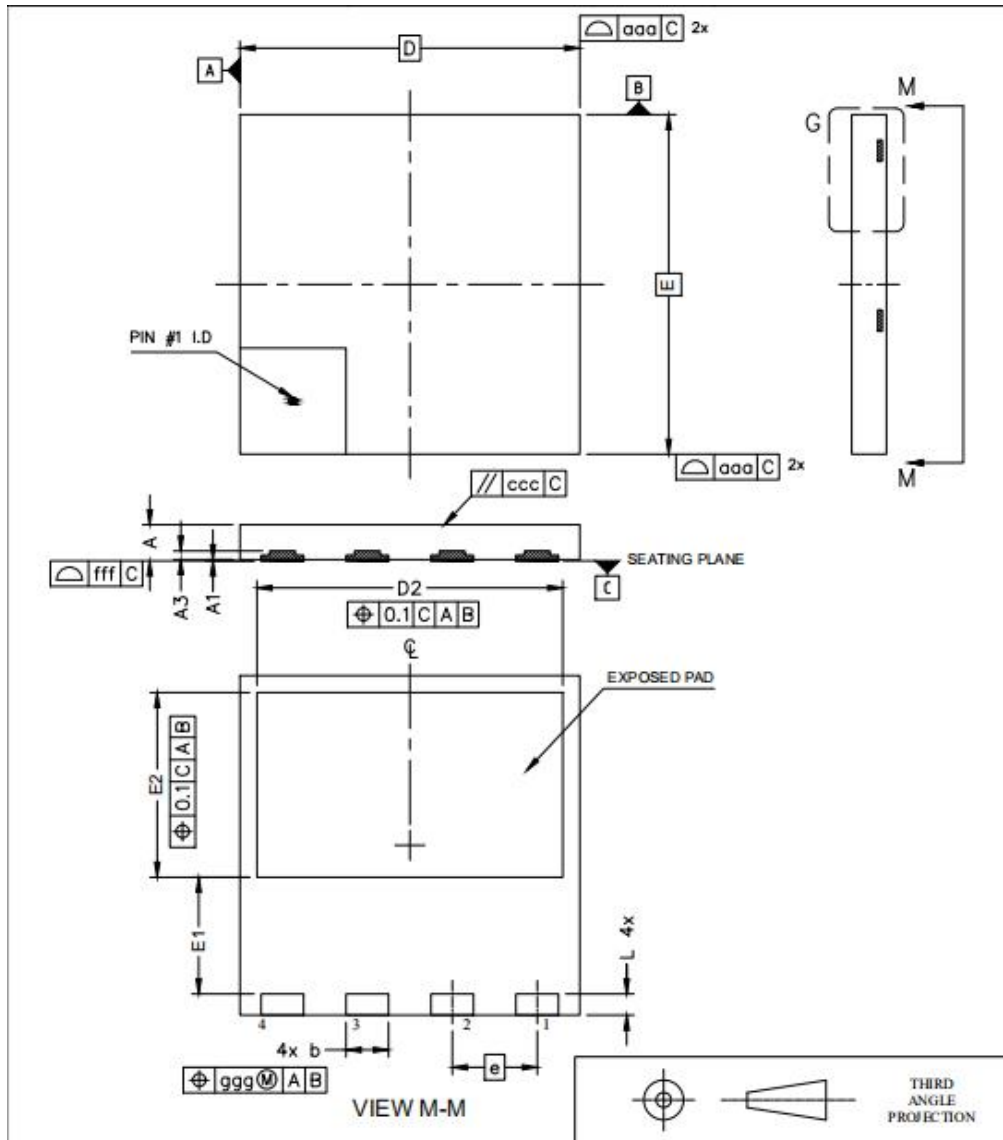


Figure C: Unclamped Inductive Switching Test Circuit and Waveform





### DNF8\*8





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